SN74BCT899 9-BIT LATCHABLE TRANSCEIVER WITH PARITY GENERATOR/CHECKER SCBS253 – JUNE 1992 – REVISED NOVEMBER 1993

- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Option to Select Generate Parity and Check or Feed-Through Data/Parity in A-to-B or B-to-A Directions
- Simultaneously Generates and Checks Parity
- Packaged in Plastic Small-Outline Package

description

The SN74BCT899 is a 9-bit to 9-bit parity transceiver with transparent latches. The device can operate as a feed-through transceiver or it can generate/check parity from the 8-bit data buses in either direction. It has a current-sinking capability of 24 mA at the A bus and 64 mA at the B bus.

The SN74BCT899 features independent latchenable (LEAB or LEBA) inputs, a select (SEL) input for ODD/EVEN parity, and separate error-signal (ERRA or ERRB) outputs for checking parity.

The SN74BCT899 is characterized for operation from 0°C to 70°C.



SN74BCT899 9-BIT LATCHABLE TRANSCEIVER WITH PARITY GENERATOR/CHECKER

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FUNCTION TABLE INPUTS **OPERATION OR FUNCTION** OEAB OEBA SEL LEAB LEBA Buses A and B are in the high-impedance state. н н Х Х Х Generates parity from B1-B8 based on ODD/EVEN. Generated parity → APAR. Generated parity н L L Х н checked against BPAR and output as ERRB. Generates parity from B1 – B8 based on ODD/ $\overline{\text{EVEN}}$. Generated parity \rightarrow APAR. Generated parity checked against BPAR and output as ERRB. Generated parity also fed back through the A latch н L L н н for generate/check as ERRA. Generates parity from B-latch data based on ODD/ $\overline{\text{EVEN}}$. Generated parity \rightarrow APAR. Generated н L L L Х parity checked against latched BPAR and output as ERRB. BPAR/B1 – B8 \rightarrow APAR/A1 – A8 feed-through mode. Generated parity checked against BPAR and L н н Х н output as ERRB. BPAR/B1-B8 → APAR/A1-A8 feed-through mode. Generated parity checked against BPAR and н L н н Н output as ERRB. Generated parity also fed back through the A latch for generate/check as ERRA. Generates parity from A1 – A8 based on ODD/EVEN. Generated parity \rightarrow BPAR. Generated parity L н L Х н checked against APAR and output as ERRA. Generates parity from A1-A8 based on ODD/EVEN. Generated parity \rightarrow BPAR. Generated parity checked against APAR and output as ERRA. Generated parity also fed back through the B latch L н L Н Н for generate/check as ERRB. Generates parity from A-latch data based on ODD/ $\overline{\text{EVEN}}$. Generated parity \rightarrow BPAR. Generated Х L Н L L parity checked against latched APAR and output as ERRA. APAR/A1 – A8 \rightarrow BPAR/B1–B8 feed-through mode. Generated parity checked against APAR and L н н Х н output as ERRA. APAR/A1-A8 → BPAR/B1-B8 feed-through mode. Generated parity checked against APAR and L н н Н Х output as ERRA. Generated parity also fed back through the B latch for generate/check as ERRB.

PARITY FUNCTION TABLE

Output to A bus and B bus

	OUTF	PUTS		
ODD/EVEN	$\Sigma \text{ OF INPUTS}$ A1 – A8 = H	APAR	BPAR‡	ERRA
L	0, 2, 4, 6, 8	L	L	Н
L	1, 3, 5, 7	L	н	L
L	0, 2, 4, 6, 8	Н	L	L
L	1, 3, 5, 7	Н	н	Н
н	0, 2, 4, 6, 8	L	н	L
н	1, 3, 5, 7	L	L	Н
н	0, 2, 4, 6, 8	Н	н	Н
Н	1, 3, 5, 7	Н	L	L

[†] If LE = H, current A1 – A8 and APAR data is used. If LE = L, latched A1–A8 and APAR data is used.

[‡] This is the value of BPAR if $\overline{SEL} = L$. If $\overline{SEL} = H$, BPAR = APAR.



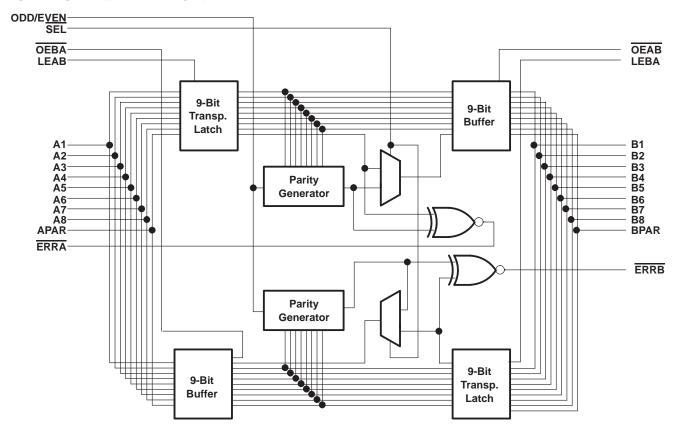
L

L

Х

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC}	-0.5 V to 7 V
Input voltage range, VI (except I/O ports) (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, VO	
Voltage range applied to any output in the high state, VO	-0.5 V to V _{CC}
Input clamp current, I _{IK} (V _I < 0)	
Current into any output in the low state, IO	128 mA
Operating free-air temperature range	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



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recommended operating conditions (see Note 2)

			MIN	NOM	MAX	UNIT
VCC	Supply voltage				5.5	V
VIH	High-level input voltage		2			V
V_{IL}					0.8	V
VI	Input voltage		0		VCC	V
	1 Path law of a strend assumed	A1-A8			-3	
ЮН	High-level output current	B1-B8			-15	mA
		A1-A8			24	
IOL	Low-level output current	B1–B8			64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10	ns/V
TA	Operating free-air temperature		0		70	°C

NOTE 2: Unused or floating pins (input or I/O) must be held high or low.



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PARAMETER			TEST	CONDITIONS	MIN	TYP†	MAX	UNIT	
VIK		V _{CC} = 4.5 V,	$V_{CC} = 4.5 V$, $I_{I} = -18 mA$			-1.2	V		
			V _{CC} = 4.75 V,	I _{OH} = -1 mA	2.7	3.4			
	A1-A8, APAR, ERRA, ERRB	1 – A8, APAR, ERRA, ERRB		I _{OH} = -1 mA	2.5	3.4			
			V _{CC} = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.3			
Vон			V _{CC} = 4.75 V,	I _{OH} = -3 mA	2.7	3.4		V	
				I _{OH} = -3 mA	2.4	3.4			
	B1–B8, BPAR		V _{CC} = 4.5 V	I _{OH} = -12 mA					
				I _{OH} = -15 mA	2	3.1			
				I _{OL} = 20 mA					
	A1–A8, APAR, ERRA, ERRB			I _{OL} = 24 mA		0.35	0.5	.,	
VOL B1-B8, BPAR	B1-B8, BPAR		V _{CC} = 4.5 V	I _{OL} = 48 mA				V	
		B1–B8, BPAR	·B8, BPAR	I _{OL} = 64 mA		0.42	0.55		
ıı‡		V _{CC} = 5.5 V,	V _I = 5.5 V			100	μA		
ι _н ‡ ι _{ιL} ‡		V _{CC} = 5.5 V,	V _I = 2.7 V			20	μA		
IIL‡			V _{CC} = 5.5 V,	V _I = 0.5 V			-20	μA	
	A1-A8, APAR, ERRA, ERRB				-60		-150		
los§	B1–B8, BPAR		V _{CC} = 5.5 V,	$V_{O} = 0$	-100		-225	mA	
	Outputs high	A to B				0.5	2		
	Outputs high B to A	B to A	7			0.5	2		
	A A A A A A A A A A A A A A A A A A A	Quitavita laur	A to B	7			43	69	
	Outputs low	B to A	1	O da da cara da		22	34		
CC		LA TO B	V _{CC} = 5.5 V,	Outputs open		6	10	mA	
Outputs disabled, ERR of	Outputs disabled, ERR outputs low	B to A	1			6	10		
		A to B]			0.5	2		
	Outputs disabled, EKR outputs high	B to A				0.5	2		
Ci			V _{CC} = 5 V,	V _I = 0.5 V		6.5		pF	
<u>.</u>	A ports					10.5		~~	
Cio	B ports		V _{CC} = 5 V,	V _O = 0.5 V		12.5		pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. [‡] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current. § Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

			V _{CC} = T _A = 2	= 5 V, 25°C	MIN	МАХ	UNIT
			MIN	MAX			
tw	Pulse duration		5		5		ns
t _{su}	Setup time before LE \downarrow	Data high or low	4.5		4.5		ns
th	Hold time after LE \downarrow	Data high or low	1.5		1.5		ns



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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Note 3)

PARAMETER	FROM	то		V _{CC} = 5 V, T _A = 25°C			MAX	UNIT
	(INPUT)	T) (OUTPUT)		TYP	MAX			
^t PLH		B or A	1.9	6	7.6	1.9	9.1	
^t PHL	A or B	BOLA	1.8	5.2	6.8	1.8	8.1	ns
^t PLH	A or B	BPAR or APAR	4.3	11	13	4.3	16.1	ns
^t PHL	AUID	DFAR UI AFAR	4.5	10.7	12.7	4.5	15.3	115
^t PLH	APAR or BPAR	BPAR or APAR	2.2	5.2	6.7	2.2	8	ns
^t PHL	AFAR UI DFAR	DFAR OFAR	1.7	4.7	6.3	1.7	7.6	115
^t PLH	A, APAR, or	ERRA or ERRB	3.4	10.6	12.6	3.4	15.7	
^t PHL	B, BPAR	ERRA UI ERRD	3.6	10.5	12.5	3.6	15.3	ns
^t PLH	ODD/EVEN	ERRA or ERRB	4.6	8.8	10.5	4.6	12.8	ns ns
^t PHL	ODD/EVEN	ERRA OFERRO	4.1	8.4	10.2	4.1	12.8	
^t PLH	ODD/EVEN		4.5	9	10.7	4.5	13.1	
^t PHL	ODD/EVEN	BPAR or APAR	4.4	8.5	10.7	4.4	13.3	
^t PLH	SEL	BPAR or APAR	1.4	4.6	6.2	1.4	7.7	
^t PHL	SEL	BPAR OF APAR	1.6	4.4	5.9	1.6	7.1	ns
^t PLH			2.6	7.6	9.3	2.6	10.9	
^t PHL	LEAB OR LEBA	B or A	3.3	6.5	8.2	3.3	9.3	9.3 ns
^t PLH	LEAB OR LEBA	BPAR or APAR	3	6.7	8.3	3	9.9	
^t PHL	LEAD OR LEDA	(parity feed-through)	3	6.1	7.7	3	8.7	ns
^t PLH		BPAR or APAR	5.2	10.2	12.1	5.2	14.8	
^t PHL	LEAB OR LEBA	(parity generated)	5.1	8.9	10.7	5.1	12.5	ns
^t PLH		ERRB or ERRA	5.3	10.3	12.3	5.3	14.9	
^t PHL	LEAB OR LEBA	EKKD UI EKKA	5	9.2	11	5	12.9	ns
^t PZH	OEAB or OEBA	D or A	1.8	5.6	7.2	1.8	9	
^t PZL	UEAB OF UEBA	B or A	2.1	10.5	12.2	2.1	13.9	ns
^t PHZ		B or A	2.9	6.4	8.1	2.9	9.8	20
^t PLZ	OEAB OF OEBA	DUIA	2.1	5.5	7.1	2.1	8.1	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74BCT899DW	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
SN74BCT899DWR	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI
SN74BCT899DWR	OBSOLETE	SOIC	DW	28	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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